

W541L260 Data Sheet



4-BIT MICROCONTROLLER

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1. GENERAL DESCRIPTION

W541L260 is fully compatible with W741L260 in the terms of pin assignment and IC function except main oscillator. It is a high-performance 4-bit microcontroller (μC) with an LCD driver. The device contains a 4-bit ALU, two 8-bit timers, two dividers, a 32×4 LCD driver, and five 4-bit I/O ports (including 1 output port to drive the LEDs). There are also five interrupt sources and 8-level subroutine nesting for interrupt applications. The W541L260 has one power reduction mode to help minimize power dissipation.

The W541L260 has two oscillator circuits and can work in dual-clock or single-clock operation mode. It is suitable for remote controllers, watches and clocks, speech synthesis LSI controllers, and other products.

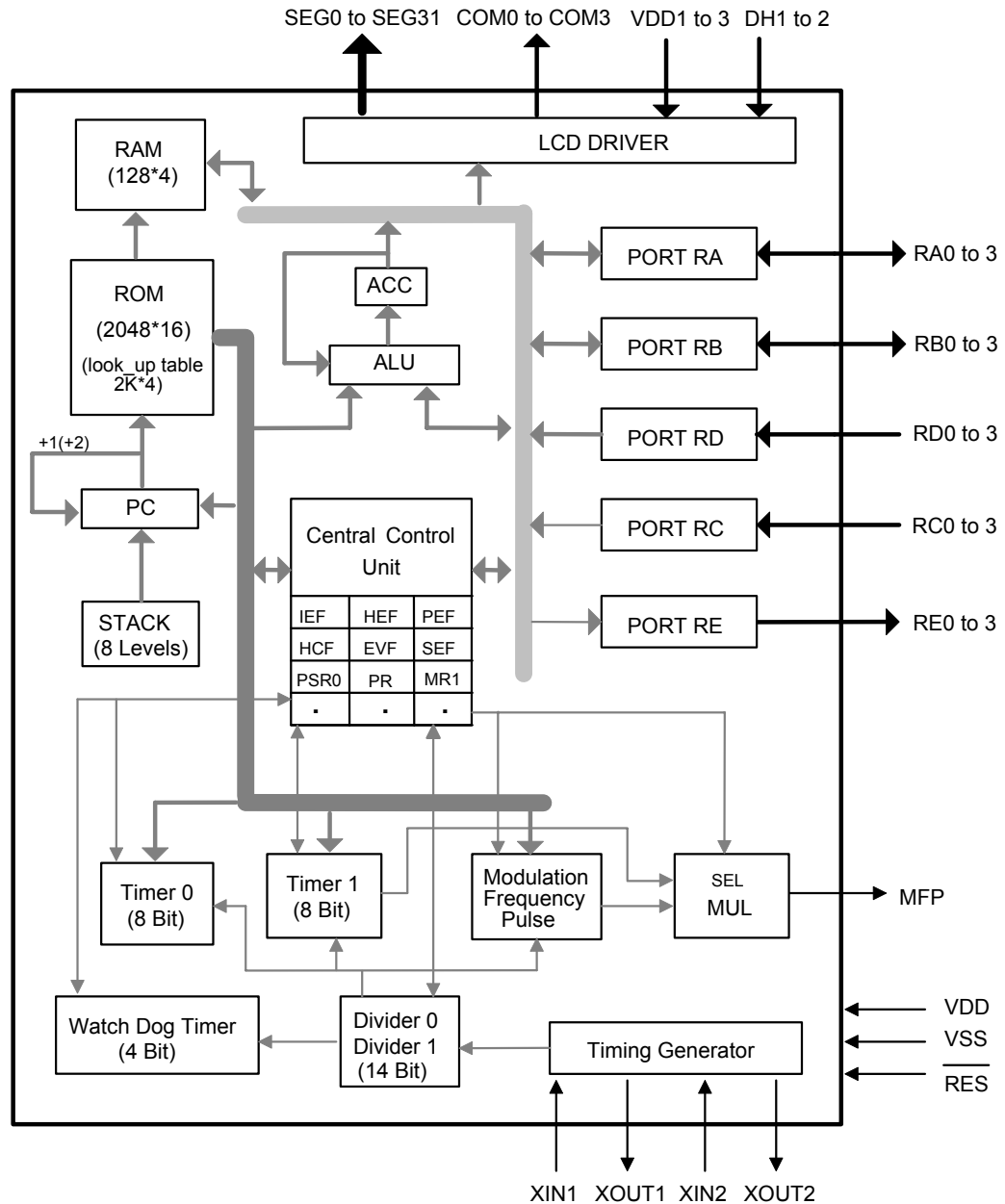
2. FEATURES

- Operating voltage: 1.2V–1.8V (LCD drive voltage: 3.0V, or 4.5V)
- Single or Dual Clock Mode
 - Single (main oscillator only) or dual clock (both main and sub-oscillator) by mask option .
 - Sub-oscillator is only 32.768 KHz crystal for dual clock mode.
 - Main oscillator is crystal or RC oscillation by mask code option .
 - Main clock : High-frequency clock (400 KHz to 1 MHz) or low-frequency clock (32.768 KHz) is selected by mask code option
- Memory
 - 2048×16 bit program ROM (including $2K \times 4$ bit look-up table)
 - 128×4 bit data RAM (including 16 working registers)
 - 32×4 LCD data RAM
- 21 input/output pins
 - Ports for input only: 2 ports/8 pins
 - Input/output ports: 2 ports/8 pins
 - Port for output only: 1 port /4 pins (high sink current to drive LEDs)
 - MFP output pin: 1 pin (MFP)
 - Do not be floating when it is as input or output open-drain (NMOS type).
- Power-down mode
 - Hold function: no operation (except for oscillator)
 - Stop function: no operation (including main clock)

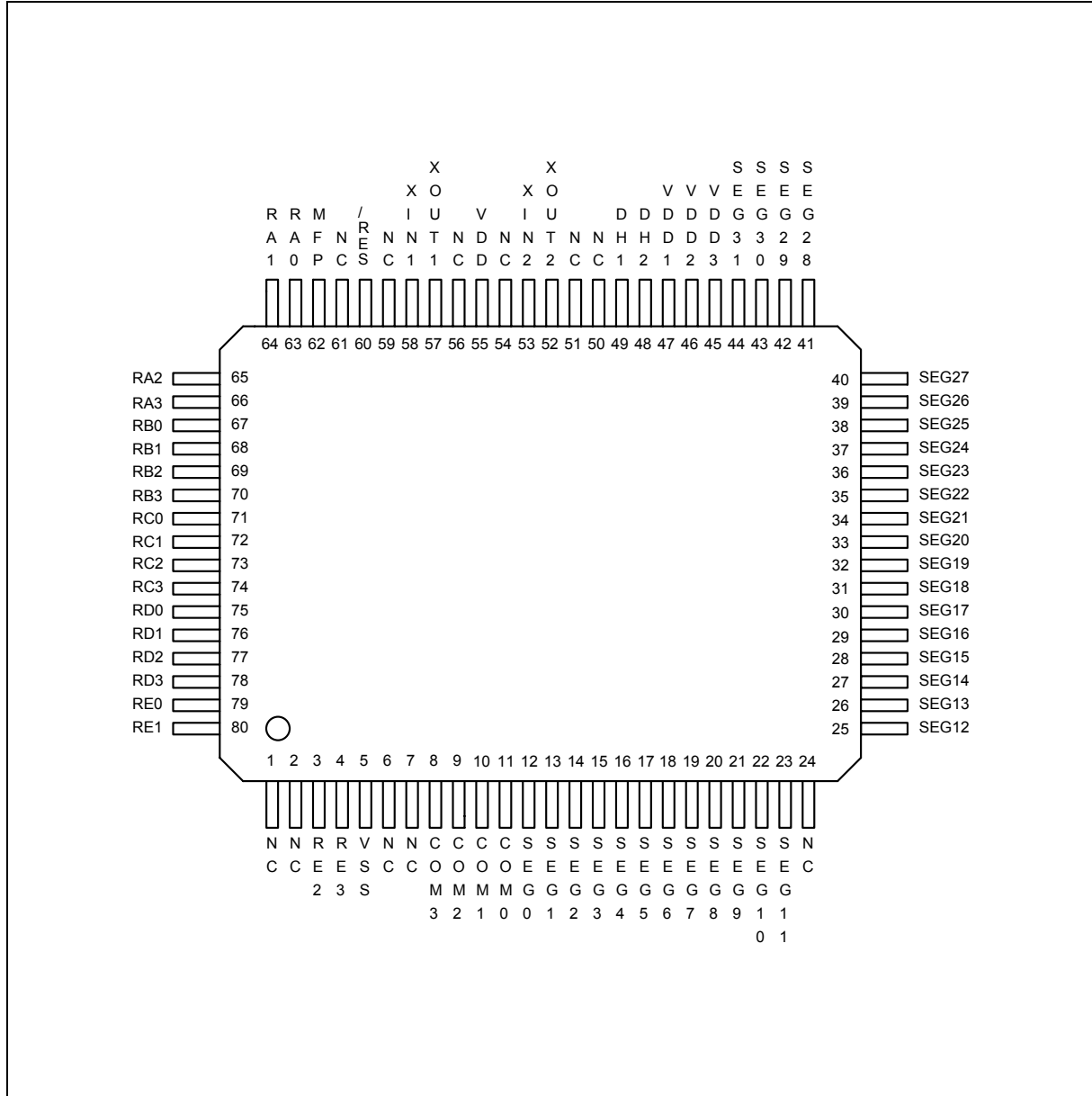


- Five types of interrupts
 - Four internal interrupts (Divider 0, Divider 1, Timer 0, Timer 1)
 - One external interrupt (Port RC)
- LCD driver output
 - 32 segment $\times$ 4 common
 - Static, 1/2 duty (1/2 bias), 1/3 duty (1/2 or 1/3 bias), 1/4 duty (1/3 bias) driving mode can be selected
 - LCD driver output pins can be used as DC output ports; selectable by code option
- MFP output pin
 - Output is software selectable as modulating or nonmodulating frequency
 - Works as frequency output specified by Timer 1
- Two built-in 14-bit clock frequency divider circuit (divider 0 and divider 1)
- Two built-in 8-bit programmable countdown timers
 - Timer 0: one of two internal clock frequencies ($F_{osc}/4$ or $F_{osc}/1024$) can be selected
 - Timer 1: includes an auto-reload function; and one of two internal clock frequencies (F_{osc} or $F_{osc}/64$) can be selected or falling edge of pin RC.0 can be selected (output through MFP pin)
- Built-in 18/14-bit watchdog timer selectable for system reset
- Powerful instruction set: 115 instructions
- 8-level subroutine (include interrupt) nesting
- Up to 4 μ S instruction cycle (with 1 MHz operating frequency)
- Packaged in 80-pin QFP

3. BLOCK DIAGRAM



4. PIN CONFIGURATION



5. PIN DESCRIPTION

SYMBOL	I/O	FUNCTION																									
XIN1	I	Input pin for oscillator. Connected to crystal or resistor to generate system clock by code option. External 10~20pF capacitor uses to get accurate freq in crystal mode.																									
XOUT1	O	Output pin for oscillator. Connected to crystal or resistor to generate system clock by code option. 20pF capacitor is built in internal for crystal mode.																									
XIN2	I	Input pin for sub-oscillator. Connected to a 32.768 KHz crystal. External 10~20pF capacitor uses to get accurate freq in crystal mode.																									
XOUT2	O	Output pin for sub-oscillator. Connected to a 32.768 KHz crystal. 20pF capacitor is built in internal for crystal mode.																									
RA0–RA3	I/O	Input/Output port. Input/output mode specified by port mode 1 register (PM1).																									
RB0–RB3	I/O	Input/Output port. Input/output mode specified by port mode 2 register (PM2).																									
RC0–RC3	I	4-bit port for input only. Each pin has an independent interrupt capability. And build-in schmitt trigger.																									
RD0–RD3	I	4-bit port for input only.																									
RE0–RE3	O	Output port only. This port provides high sink current to drive LEDs.																									
MFP	O	Output pin only. This pin can output modulating or nonmodulating frequency, or Timer 1 clock output specified by mode register 1 (MR1).																									
RES	I	System reset pin with pull-high resistor.																									
SEG0–SEG31	O	LCD segment output pins. Can also be used as DC output ports specified by code option.																									
COM0–COM3	O	LCD common signal output pins. <table border="1"><thead><tr><th></th><th>Static</th><th>1/2 Duty</th><th>1/3 Duty</th><th>1/4 Duty</th></tr></thead><tbody><tr><td>COM0</td><td>Used</td><td>Used</td><td>Used</td><td>Used</td></tr><tr><td>COM1</td><td>Not Used</td><td>Used</td><td>Used</td><td>Used</td></tr><tr><td>COM2</td><td>Not Used</td><td>Not Used</td><td>Used</td><td>Used</td></tr><tr><td>COM3</td><td>Not Used</td><td>Not Used</td><td>Not Used</td><td>Used</td></tr></tbody></table> The LCD alternating frequency can be selected by code option.		Static	1/2 Duty	1/3 Duty	1/4 Duty	COM0	Used	Used	Used	Used	COM1	Not Used	Used	Used	Used	COM2	Not Used	Not Used	Used	Used	COM3	Not Used	Not Used	Not Used	Used
	Static	1/2 Duty	1/3 Duty	1/4 Duty																							
COM0	Used	Used	Used	Used																							
COM1	Not Used	Used	Used	Used																							
COM2	Not Used	Not Used	Used	Used																							
COM3	Not Used	Not Used	Not Used	Used																							
DH1, DH2	I	Connection terminals for voltage doubler (halver) capacitor.																									
VDD1, VDD2 VDD3	I	Positive (+) supply voltage terminal. Refer to Functional Description.																									
VDD	I	Positive power supply (+).																									
VSS	I	Negative power supply (-).																									



6. ELECTRICAL CHARACTERISTICS

6.1 Absolute Maximum Ratings

PARAMETER	RATING	UNIT
Supply Voltage to Ground Potential	-0.3 to +7.0	V
Applied Input/Output Voltage	-0.3 to +7.0	V
Power Dissipation	120	mW
Ambient Operating Temperature	0 to +70	°C
Storage Temperature	-55 to +150	°C

Note: Exposure to conditions beyond those listed under Absolute Maximum Ratings may adversely affect the life and reliability of the device.

6.2 DC Characteristics

(VDD-VSS = 1.5V, Fosc. = 32.768 KHz, TA = 25° C; unless otherwise specified)

PARAMETER	SYM.	CONDITIONS	MIN.	TYP.	MAX.	UNIT
Op. Volt (Crystal type)	VDD1	High-frequency Oscillation	1.35	-	1.8	V
Op. Volt (RC type)	VDD2	High-frequency Oscillation	1.2	-	1.8	V
Op. Volt (RC, Crystal)	VDD3	Low-frequency Oscillation	1.2	-	1.8	V
Op. Current (RC Type)	IOP2	No load (Ext-V) In dual-clock normal operation	-	100	400	μA
Op. Current (Crystal Type)	IOP3	No load (Ext-V) In dual-clock slow operation and Fm is stopped	-	8.5	20	μA
Hold Current (RC Type)	IHM2	Hold mode No load (Ext-V) In dual-clock normal operation	-	60	100	μA
Hold Current (Crystal Type)	IHM3	Hold mode No load (Ext-V) In dual-clock slow operation and Fm is stopped	-	4.0	6	μA
Stop Current (Crystal type)	ISM1	Stop mode No load (Ext-V) In dual-clock normal operation	-	4.0	6	μA
Stop Current (Crystal type)	ISM2	Stop mode No load (Ext-V) In single-clock operation	-	0.1	2	μA

DC Characteristics, continue

PARAMETER	SYM.	CONDITIONS	MIN.	TYP.	MAX.	UNIT
Input Low Voltage	V _{IL}	-	V _{SS}	-	0.3 V _{DD}	V
Input High Voltage	V _{IH}	-	0.7 V _{DD}	-	V _{DD}	V
MFP Output Low Voltage	V _{ML}	I _{OL} = 0.9 mA	-	0.1	0.3	V
MFP Output High Voltage	V _{MH}	I _{OH} = 0.75 mA	1.2	1.4	-	V
Port RA, RB Output Low Voltage	V _{ABL}	I _{OL} = 1.0 mA	-	0.2	0.3	V
Port RA, RB Output High Voltage	V _{ABH}	I _{OH} = 0.5 mA	1.2	1.4	-	V
LCD Supply Current	I _{LCD}	All Seg. ON	-	-	6	μA
SEG0–SEG31 Sink Current (Used as LCD Output)	I _{OL1}	V _{OL} = 0.05V V _{LCD} = 0.0V	6	12	-	μA
SEG0–SEG31 Drive Current (Used as LCD Output)	I _{OH1}	V _{OH} = 4.45V V _{LCD} = 4.5V	1.5	12	-	μA
Segment Output Low Voltage (Used as DC Output)	V _{SL}	I _{OL} = 150 μA	-	0.1	0.15	V
Segment Output High Voltage (Used as DC Output)	*V _{SH}	I _{OH} = 1 μA	1.05	1.4	-	V
Port RE Sink Current	I _{EL}	V _{OL} = 0.3V	2	-	-	mA
Port RE Source Current	I _{EH}	V _{OH} = 1.2V	0.35	0.45	-	mA
Input Port Pull-up Resistor	R _{CD}	Port RC, RD	200	1000	1500	KΩ
$\overline{\text{RES}}$ Pull-up Resistor	R _{RES}	-	200	500	1500	KΩ

Note : *V_{SH}: Its ability is based on LCD power connected to 0.1 μF capacitor.

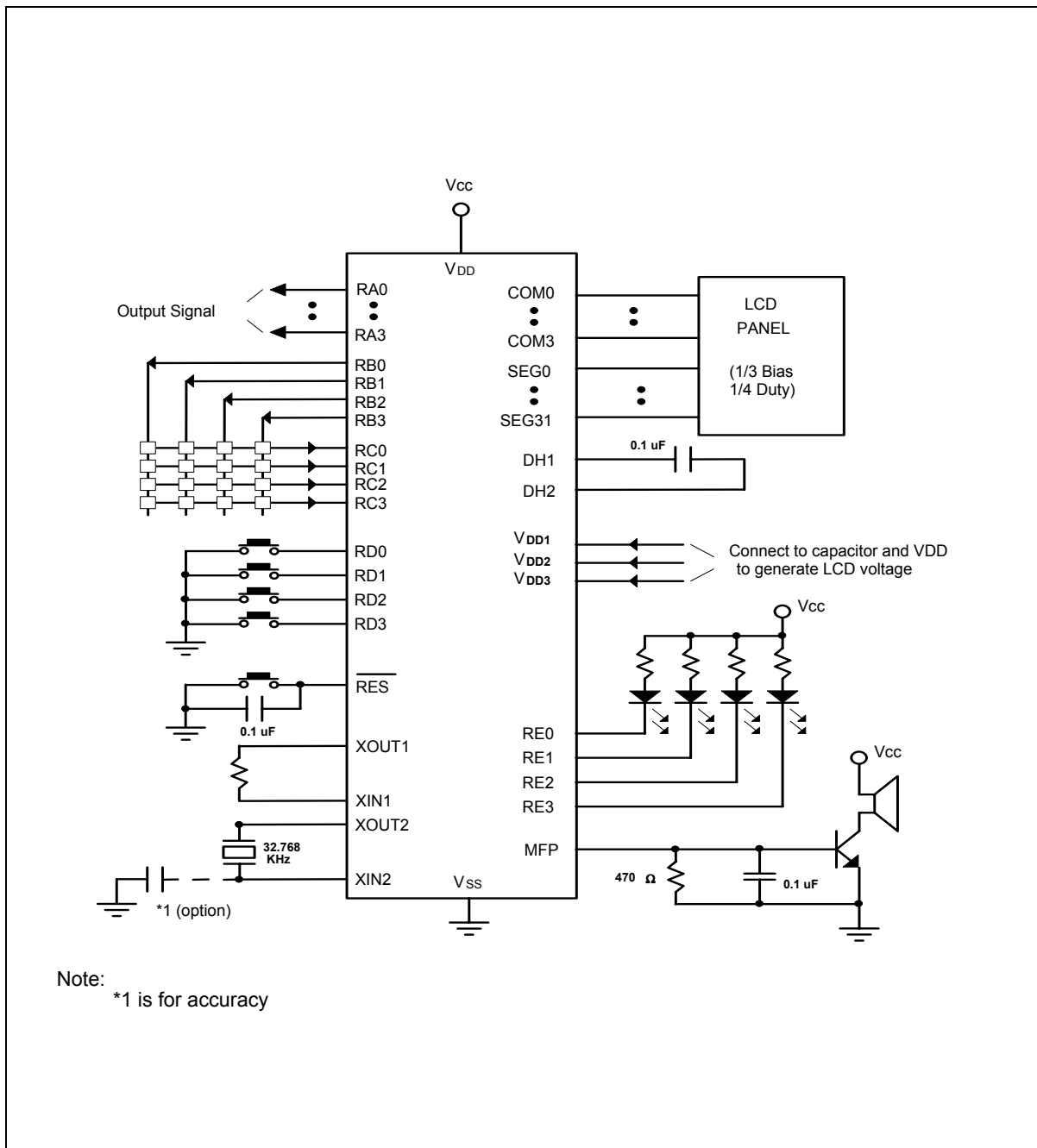


6.3 AC Characteristics

(V_{DD}-V_{SS} = 1.5V, T_A = 25° C, unless otherwise specified)

PARAMETER	SYM.	CONDITIONS	MIN.	TYP.	MAX.	UNIT
Op. Frequency	FOSC	RC type	-	-	1000	KHz
		Crystal type (Option low speed type only)	-	32.768	-	
Frequency Deviation by Voltage Drop for RC Oscillator	$\frac{\Delta f}{f}$	$\frac{f(1.5V) - f(1.2V)}{f(1.5V)}$	-	-	10	%
Oscillator Start-up Time	T _S	V _{DD} =1.2 V, FOSC=32.768 KHz	-	1	2	S
Instruction Cycle Time	T _I	One machine cycle	-	4/FOSC	-	mS
Reset Active Width	T _{RAW}	FOSC = 32.768 KHz	1	-	-	μS
Interrupt Active Width	T _{IAW}	FOSC = 32.768 KHz	1	-	-	μS

7. APPLICATION CIRCUIT





8. REVISION HISTORY

VERSION	DATE	DESCRIPTION
A2	-	Note: Recommend working voltage range for Hi freq X al mode (L series)
A3	-	Note: RC is built-in schmitt trigger
A4	May 29, 2003	Note: Do not be floating when it is as input or output open-drain (NMOS type)



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